A,	W,	H,	McL &	ίN	Docket	No	٠
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## **Declaration For U.S. Patent Application**

ARMSTRONG, WE

As a below named inventor, I hereby declare that:

My residence, p	ost office	address and	citizenship	are as stated	below	next to my	name.
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My residence, post offi	ce address and citizenship are as stated	below next to my name.				
names are listed below Insert Title) METHO	nal, first and sole inventor (if only one) of the subject matter which is claimed DO FOR MANUFACTURING SO TABRIC THEREFOR	l and for which a patent is	sought on the invention entitled	or (if plural I		
he specification of wh	ich is attached hereto unless the follow	ing is checked:				
	filed on	as United	States Application Number or P	CT International		
*	ication Number	and was amended on				
· —	oplicable).		-			
hereby state that I hat you amendment ref	ve reviewed and understand the content erred to above.					
acknowledge the duty	to disclose information which is materi	al to patentability as define	ed in Title 37, Code of Federal Re	egulations, § 1.36.		
inventor's certificate li	priority benefits under Title 35, United isted below and have also identified below application on which priority is cla	ow any foreign application	(d) of any foreign application(s) in for patent or inventor's certific	cate naving a m-		
Europe Too Too	44 452542	_	10/6/99	Priority Claimed  ☑ Yes ☐ No		
List prior foreign	11-163619 (Number)	Japan (Country)	(Day/Month/Year Filed)	Yes No		
applications. See note A	(Number)	(Country)	(Day/Month/Year Filed)	_		
on back of this page)	(Number)	(Country)	(Day/Month/Year Filed)	_ □ Yes □ No		
	(Number)	(Country)	(Day/Month/Year Filed)			
(See note B on back o	f this page)	l list for additional prior fo	oreign applications			
I hereby claim the ber	nefit under Title 35, United States Code	, § 119(e) of any United S	tates provisional application(s)	isted below.		
			(Filing Date)			
	(Application Number)		(Filling Date)			
	(Application Number)		(Filing Date)			
subject matter of each the first paragraph of ity as defined in Title	nefit under Title 35, United States Code a of the claims of this application is not Title 35, United States Code, § 112, I a 37, Code of Federal Regulations, § 1.5 CT international filing date of the applic	disclosed in the prior Unicknowledge the duty to di 6 which became available	ted States application in the mai isclose information which is mat	erial to patentabil-		
(List Prior U.S. Applications)	(Application Serial Number)	(Filing Date)	(Filing Date) (Status) (patented, pending			
	(Application Serial Number)	(Filing Date)	(Status) (patented, pendi	ng, abandoned)		
I hereby appoint the f	following attorney(s) and/or agent(s) to	prosecute this application	and to transact all business in the	he Patent and		

20,276; Edward F. Welsh, Reg. No. 22,455; Patrick D. Muir, Reg. No. 37,403; Gay A. Spahn, Reg. No. 34,978; John P. Kong, Reg. No. 40,054; and Luke A. Kilyk, Reg. No. 33,251.

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

	Full name of sole or first inventor (given name, family name) Hiroshi UCHIDA			
(See note C above)	Inventor's Signature / dringshi (lelaida Date 15/3/2000 141-3, Horiage-cho,			
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Full name of third	d inventor (given name, family name) <u>Masahiro SHTNYA</u>			
	ure <u>Marahwa Shinya</u> Date 15/3/2000 NAGOYA Aerospace Systems Works, MITSUBISHI HEAVY INDUSTRIES, LTD.,			
E C/O	NAGOYA Aerospace Systems Works, MITSUBISHI HEAVY INDUSTRIES, LTD., ye-cho, Minato-ku Nagoya, Aichi-KEN, Japan Citzenship Japan			
	ess Same as above			
≢ .	rth inventor (given name, family name)			
ž ±	ureDate			
Li	Citizenship			
Post Office Addre	ess			
Tull name of fifth	n inventor (given name, family name)			
Inventor's Signat	ureDate			
Residence	Citizenship			
Post Office Addre	ess			
Full name of sixt	h inventor (given name, family name)			
Inventor's Signat	ureDate			
Residence	Citizenship			
Post Office Addr	ess			
Full name of seve	enth inventor (given name, family name)			
Inventor's Signat	tureDate			
Residence	Citizenship			
Post Office Addr	ess			
Full name of eigh	hth inventor (given name, family name)			
Inventor's Signature				
	Citizenship			
	ess			